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Reference design HEMJ [1] (Fig. 1)

- Nominal heat flux 10 MW/m².
- Cooling: impinging multiple helium jets (10 MPa, 600°C).
- Hex. W tile (18mm A/F) brazed to WL10 thimble (Ø15 x 1 mm), joined with ODS Eurofer back bone structure.

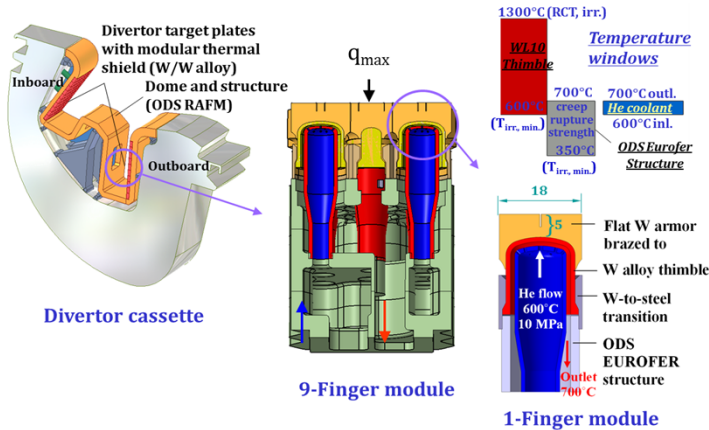


Fig. 1: Reference HEMJ design: Heat removal by helium jet impingement (10 MPa, 600 ° C)

Problem: unknown irradiated data for W materials

| Material | DBTT _{unirr.} (°C) | ΔDBTT @ dpa/T _{irr.} (°C) | T _{irr.} , ΔDBTT, minor* (°C) |
|-------------|-----------------------------|------------------------------------|--|
| Eurofer [3] | -90 | 235 @ 70/330 | 350 |
| W [4] | -650 (rod, Ø20 mm) | unknown | unknown |
| WL10 [4] | 400-450 (rod, Ø20 mm) | unknown | unknown |
| T-111 [2] | -190 | unknown | unknown |

*above which only minor DBTT shift is expected

Alternative HEMJ design with T-111 thimble (Fig. 2)

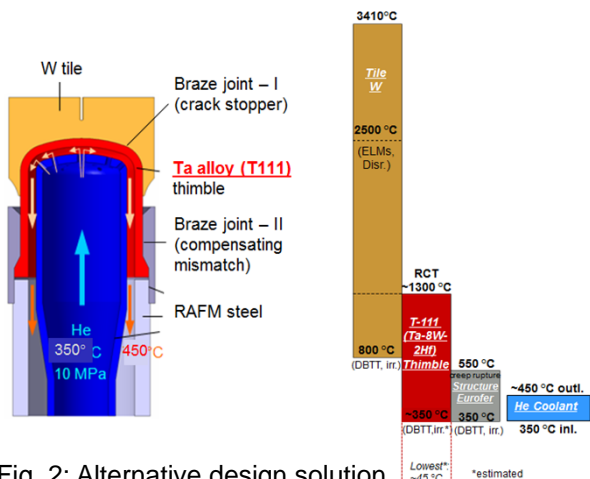


Fig. 2: Alternative design solution.

- [1] P. Norajitra et al., *Fusion Eng. Des.* 83 (2008) 893–902.
[2] NASA Technical Note, NASA TN D-5873, *Survey of Properties of T-111*.
[3] E. Gaganidze et al., *J. Nucl. Mater.* 355 (2006) 83–88.
[4] M. Rieth, <http://bibliothek.fzk.de/zb/veroeff/79094.pdf>,
<http://bibliothek.fzk.de/zb/veroeff/81120.pdf>, retrieved 03.06.2013.

Advantages of T-111 [2] as alternative thimble material

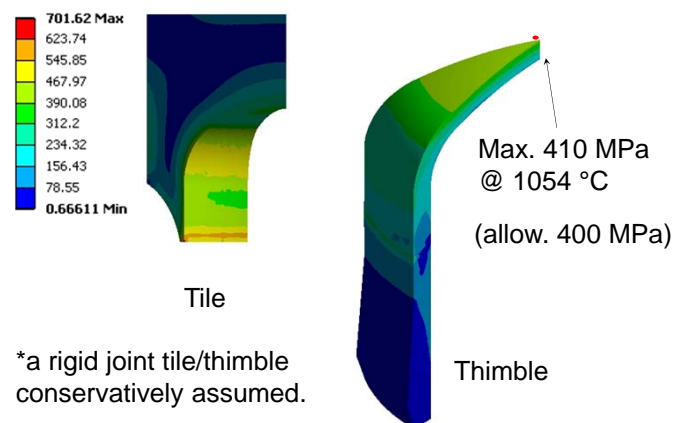
- High creep resistant at T ~ 980 – 1310 °C.
- Extremely low DBTT of -196 °C.
- Good formability and weldability.
- Corrosion resistance to liquid alkali metals (Li, Na, K).

Design Verification by CFD and FEM Analyses

Table 1: Boundary conditions (top) and result summary (bottom) of CFD analysis.

| | Reference case (Thimble WL10) | Thimble T-111 |
|---|-------------------------------|---------------|
| Mass flow rate per finger (g/s) | 6.8 | 6.8 |
| He inlet temperature (°C) | 634 | 350 |
| He pressure (MPa) | 10 | 10 |
| He density (kg/m ³) | 5.2 | 7.0 |
| Heat flux (MW/m ²) | 10 | 10 |
| Volumetric heat generation (MW/m ³) | 17 | 17 |

| | Reference case (Thimble WL10) | Thimble T-111 |
|-------------------------|-------------------------------|---------------|
| Max. tile temp. (°C) | 1783 | 1606 |
| Max. thimble temp. (°C) | 1201 | 1055 |
| He outlet temp. (°C) | 712 | 429 |
| Max. He velocity (m/s) | 245 | ~170 |
| Pressure loss (MPa) | 0.12 | 0.08 |



*a rigid joint tile/thimble conservatively assumed.

Fig. 3: Von Mises equivalent stress* (MPa) by ANSYS for T-111 case, (heat flux 10 MW/m², T_{He} 350 ° C).

Conclusion

- An alternative solution with T-111 material may satisfy the requirements on the ductility of thimble structure.
- The chosen coolant temperature of 350 °C allows for the simplistic application of Eurofer base material instead of ODS Eurofer.